

Appl. Ser. No. 10/737,240

Resubmission Amend A in Resp to O/A 5/26/05

IN THE SPECIFICATION:

Please amend the Specification, Page 20, Line 27-29, as follows:

Brief Description of the Drawings

FIG. 1a through 1d describes the prior art, presenting the features for screen printing solder paste, and the like, onto a printed circuit assembly, integrated circuit wafer, and the like.

FIG. 2 teaches the limitations of the prior art, describing an aspect ratio.

FIG. 3 is a flow diagram showing the steps of the print release portion of the present invention.